## imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

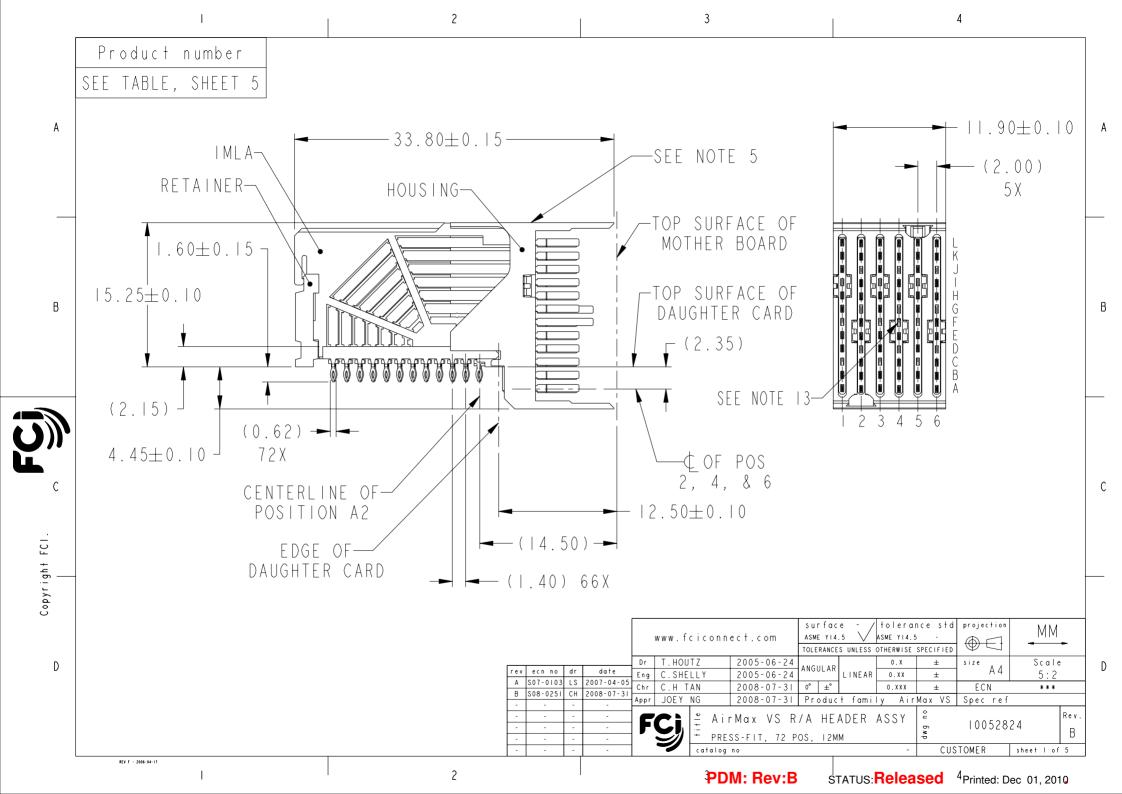
We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

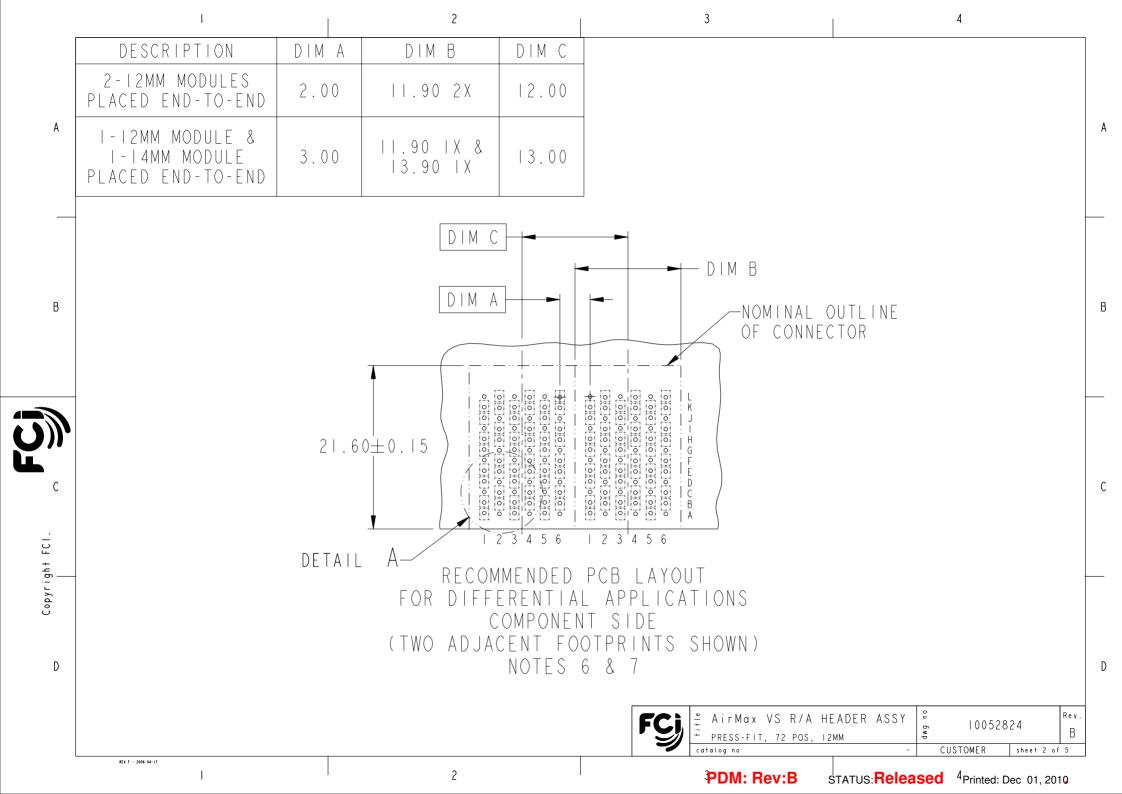


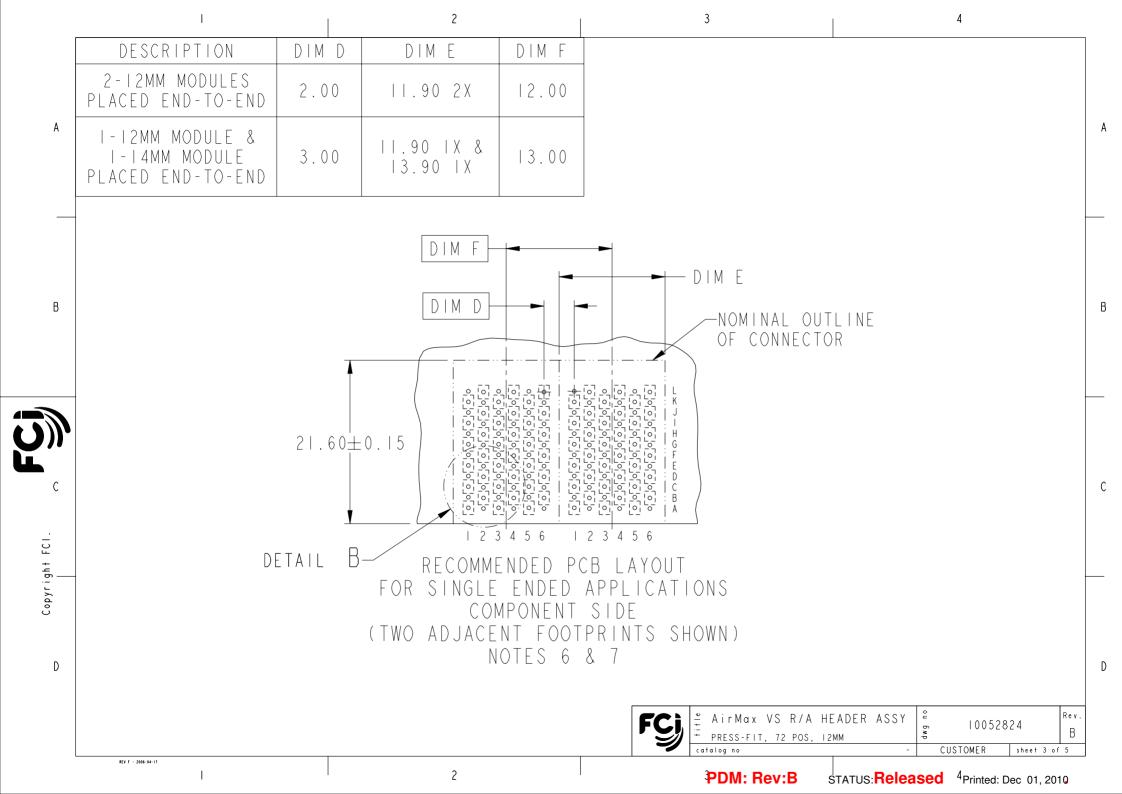
## Contact us

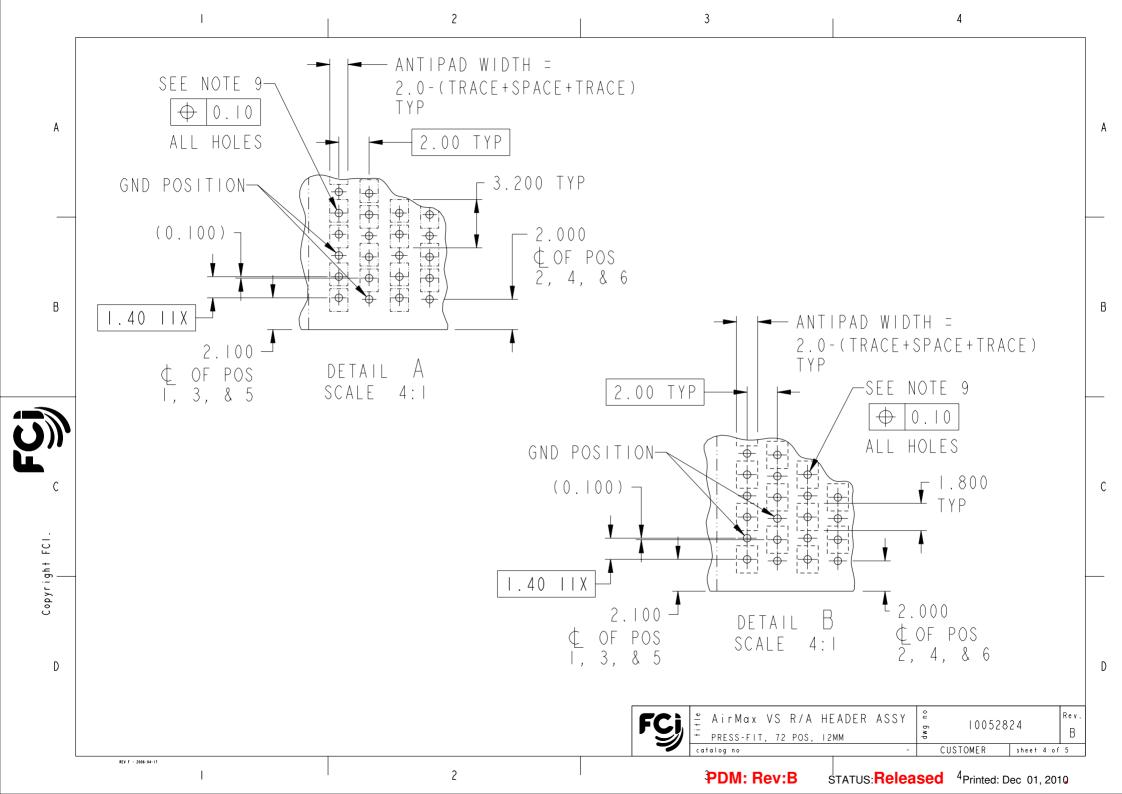
Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China











		I		2		3			4		
A	PART NUMBER	PRESS-FIT TAIL PLATING TYPE	SHORT DETECT CONTACT				I				
	10052824-101	TIN/LEAD ALLOY OVER NICKEL									
	10052824-101LF	TIN OVER NICKEL (LEAD FREE)	NO								A
	10052824-111	TIN/LEAD ALLOY OVER NICKEL	YES								
	10052824-111LF	TIN OVER NICKEL (LEAD FREE)	(SEE NOTE 13)								_
	NOTES:						. 198				
В	HOUSING & RETAINER: HIGH TEMP THERMOPLASTIC, NATURAL, UL94V-0										В
	2. CONTACT PLATING: SEPARABLE INTERFACE: PERFORMANCE-BASED PLATING, QUALIFIED TO MEET THE REQUIREMENTS OF FCI PRODUCT SPECIFICATION GS-12-239, INCLUDING TELECORDIA CR 1217 CORE (NOVEMERER 1005)										_
<b>S</b>	INCLUDING TELCORDIA GR-1217-CORE (NOVEMEBER 1995) CENTRAL OFFICE. PRESS-FIT TAILS: SEE TABLE						COUNTRY RE		DN DIRECTIVES 5 DESCRIBED IN		
C Copyright FCI.	3. PRODUCT S	I	I. THE HOUSI PEAK TEMP	NG WILL WI ERATURE FOR	THSTAND EXPOS R 40 SECONDS	SURE TO 260°C IN A CONVECTI	ON,	C.			
	4. APPLICATI	ON SPECIFICATIO		INFRA-RED	OR VAPOR I	PHASE REFLOW	OVEN.		v		
	5. PRODUCT M	1ARKING, (PART N	NUMBER & LOT C	ODE), ON THIS SURFAC	CE I	2. PACKAGING SPECIFICA		14-920 LEAD F	REE LABELING		
	6.) REFER TO PCB LAYOU	CUSTOMER DRAWIN JT OF POWER AND	NG 10035911 FC GUIDE MODULES	OR INFORMATION REGARI 5 RELATIVE TO SIGNAL	MODULES V	🔨 SIGNAL PI	NS. NOMINA	ORTER THAN AL AL MATING WIP	E FOR PIN F4		_
	7. POSITIONS OF EVEN N	S F OF ODD NUMBE NUMBERED COLUMNS	ERED COLUMNS A S CORRESPOND T	ND POSITIONS G O EARLY MATE HEADER	PINS	<u>B</u> IS 0.5MM	LESS THAN /	ALL REMAINING	6 SIGNAL PINS.		
	8. THERE IS	NO GROUND BUSSI	ING WITHIN THE	CONNECTOR SYSTEM				e next to an I has been mo			D
	9. REFER TO	CUSTOMER DRAWIN S AND PLATING OF	NG 10045979 FC Ptions		B HOLE		ENT DRAWING				-
					F		VS R/A HEA 1, 72 POS, 12MM	d w b	10052824 USTOMER   sheet 5 o	Rev. B	
	REV F - 2006-04-17	1		2		PDM: R	lev:B STA	TUS:Released	<sup>4</sup> Printed: Dec 01, 20	)10	